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 Siemens AG
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8 UNITED STATES DISTRICT COURT
 9 NORTHERN DISTRICT OF CALIFORNIA
 10 San Jose Division

11 APPLE INC., a California corporation,
 12 Plaintiff,
 13 vs.
 14 SAMSUNG ELECTRONICS CO., LTD., a
 Korean corporation; SAMSUNG
 15 ELECTRONICS AMERICA, INC., a New York
 corporation; and SAMSUNG
 16 TELECOMMUNICATIONS AMERICA, LLC, a
 Delaware limited liability company,
 17 Defendants.
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No.: 11-cv-01846-LHK (PSG)

**[PROPOSED] ORDER GRANTING
 SIEMENS AG'S ADMINISTRATIVE
 MOTION TO SEAL**

Honorable Lucy H. Koh

REED SMITH LLP
 A limited liability partnership formed in the State of Delaware

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Non-party Siemens AG filed an administrative motion to seal portions of Trial Exhibit 77 on July 30, 2012. Siemens AG’s Motion to Seal is hereby GRANTED. Consistent with and to the extent described in Siemens AG’s motion to seal and supporting declarations, the documents at issue may be filed under seal if they are used during trial:

1. Sections 1.3, 1.4, 1.5, 2 (entire section), 4 (entire section), 5 (entire section) of the Patent License Agreement [Nuzzi Decl., Exh. A.]; and

2. The redacted portion of Samsung Electronics Co., LTD’s summary of the Patent License Agreement [Nuzzi Decl., Exh. B.].

IT IS SO ORDERED.

Dated: _____

Hon. Lucy H. Koh

United States District Judge